

MS AMENDMENT PATENT 0171-0990P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:

OSADA, Shoichi et al. Conf.:

Appl. No.:

10/617,827

Group:

1712

Filed:

July 14, 2003

Examiner: Zimmer, Marc S.

For:

SEMICONDUCTOR ENCAPSULATING EPOXY RESIN

COMPOSITION AND SEMICONDUCTOR DEVICE

LARGE ENTITY TRANSMITTAL FORM

MS AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 April 26, 2005

Transmitted herewith is an amendment in the above-identified application.

\sqcup	The enclosed document	is being	transmitted via	the Certificate
	of Mailing provision	s of 37 C	.F.R. § 1.8.	

The enclosed document is being transmitted via facsimile.

The fee has been calculated as shown below:

	Claims Remaining After Amendment		HIGHEST NUMBER PREVIOUSLY PAID FOR		Present Extra	RATE	ADDITIONAL PEE
TOTAL	9	-	20	=	0	\$50	\$0.00
INDEPENDENT	1	-	3	=	0	\$200	\$0.00
FIRST PRESEN	TATION OF A	MULT	TIPLE DEPENDE	NT CL	AIM	\$360	\$0.00
						TOTAL	\$0.00

		nth(s) extension of time pursuant to 136(a). \$0.00 for the extension of						
	No fee is required.							
	Check(s) in the amount of \$0.00 is(are) enclosed.							
	Please charge Deposit Account No. $02-2448$ in the amount of \$0.00. This form is submitted in triplicate.							
If necessary, the Commissioner is hereby authorized in this concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 02-2448 for any additional fees required under 37 C.F.R. § 1.16 or under 37 C.F.R. § 1.17 particularly, extension of time fees.								
	R	Respectfully submitted,						
	В	BIRCH, STEWART, KOLASCH & BIRCH, LLP						
	В	A Munus						
	P	Gerald M. Murphy, Jr., #28,977						
GMM/		Falls Church, VA 22040-0747						
0171	L-0990P ((703) 205-8000						

Attachment(s)